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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 6x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	20-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc770-e-p

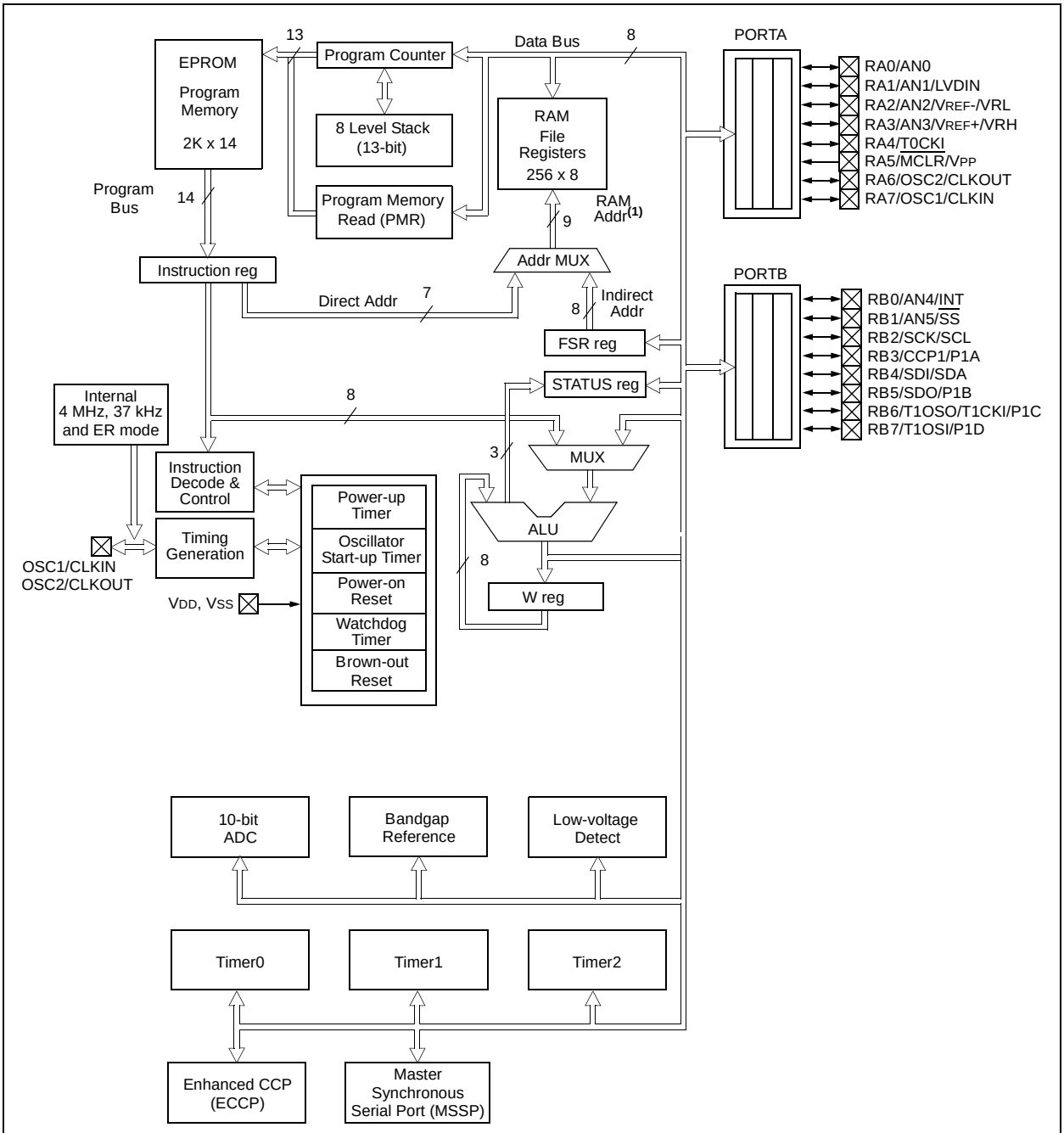
1.0 DEVICE OVERVIEW

This document contains device-specific information. Additional information may be found in the PICmicro™ Mid-Range MCU Family Reference Manual, (DS33023), which may be obtained from your local Microchip Sales Representative or downloaded from the Microchip website. The Reference Manual should be considered a complementary document to this data sheet, and is highly recommended reading for a better understanding of the device architecture and operation of the peripheral modules.

There are three devices (PIC16C717, PIC16C770 and PIC16C771) covered by this data sheet. The PIC16C717 device comes in 18/20-pin packages and the PIC16C770/771 devices come in 20-pin packages.

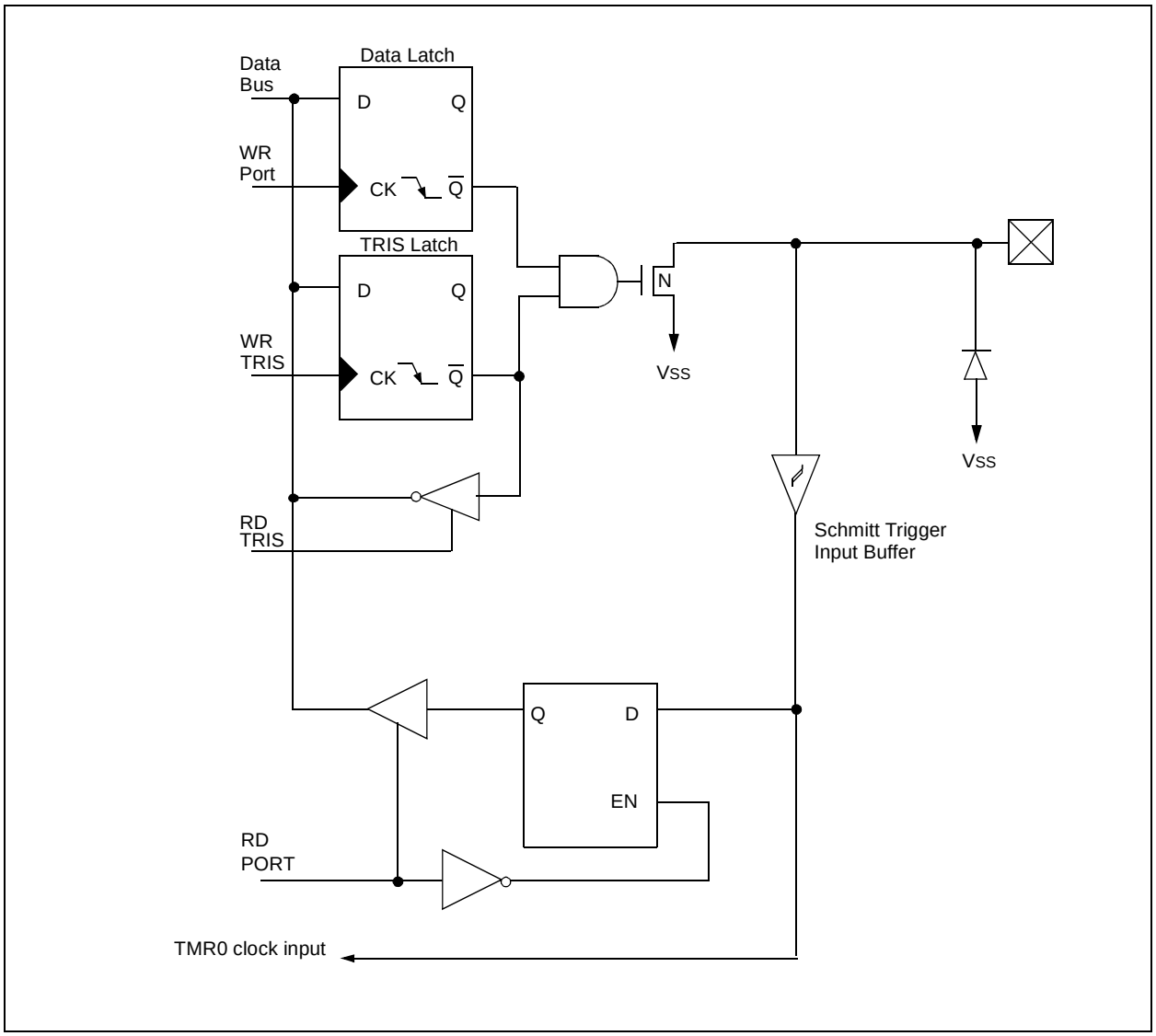
The following two figures are device block diagrams of the PIC16C717 and the PIC16C770/771.

FIGURE 1-1: PIC16C717 BLOCK DIAGRAM



Note 1: Higher order bits are from the STATUS register.

FIGURE 3-3: BLOCK DIAGRAM OF RA4/T0CKI



REGISTER 3-2: WEAK PULL-UP PORTB REGISTER (WPUB: 95h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0
bit 7							bit 0

bit 7-0 **WPUB<7:0>:** PORTB Weak Pull-Up Control bits

1 = Weak pull-up enabled
0 = Weak pull-up disabled

Note 1: For the WPUB register setting to take effect, the $\overline{\text{RBPU}}$ bit in the OPTION_REG register must be cleared.

2: The weak pull-up device is automatically disabled if the pin is in Output mode (TRIS = 0).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 3-3: INTERRUPT-ON-CHANGE PORTB REGISTER (IOCB: 96h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
IOCB7	IOCB6	IOCB5	IOCB4	IOCB3	IOCB2	IOCB1	IOCB0
bit 7							bit 0

bit 7-0 **IOCB<7:0>:** Interrupt-on-Change PORTB Control bits

1 = Interrupt-on-change enabled
0 = Interrupt-on-change disabled

Note: The interrupt enable bits GIE and RBIE in the INTCON Register must be set for individual interrupts to be recognized.

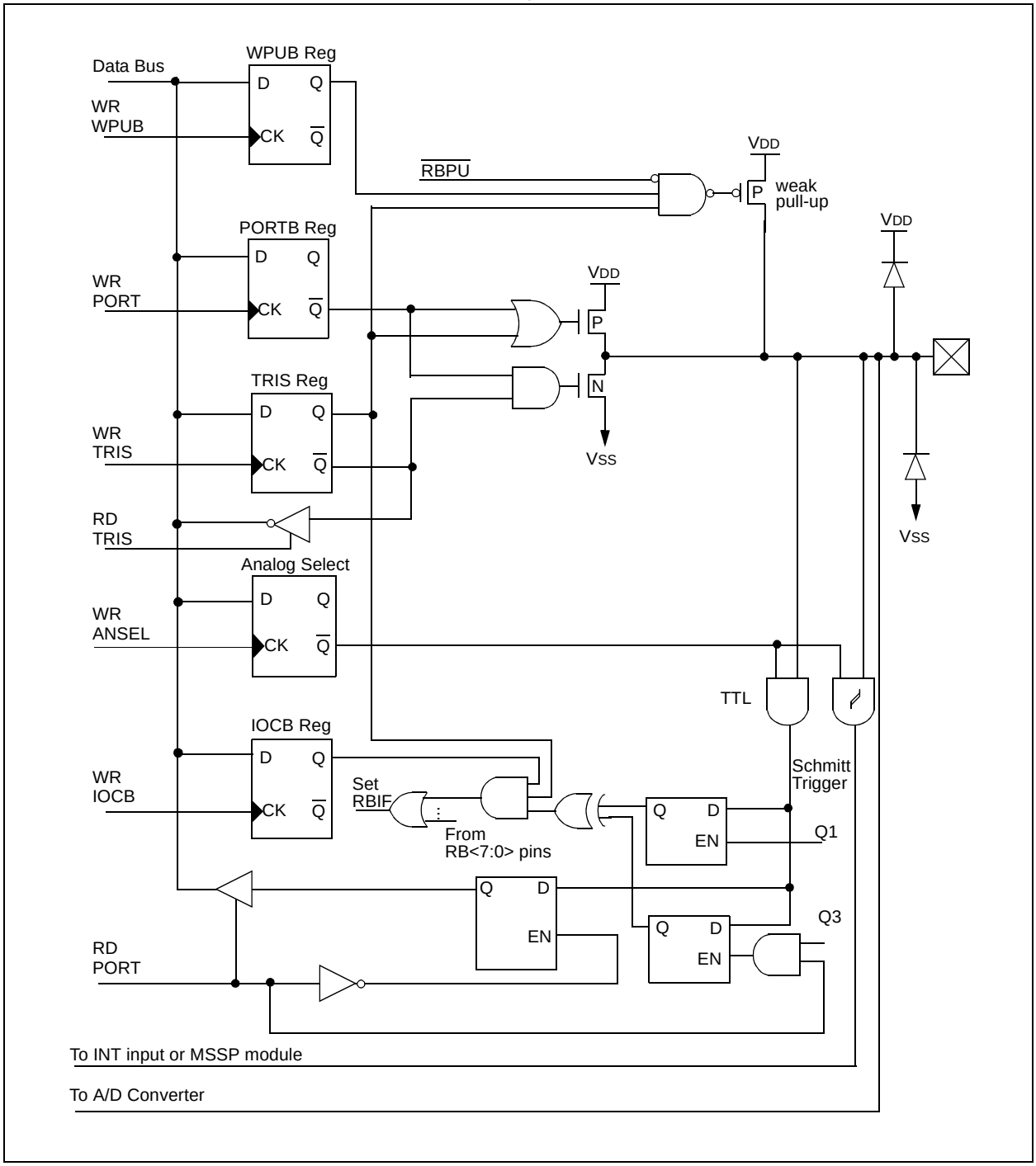
Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The RB0 pin is multiplexed with the A/D converter analog input 4 and the external interrupt input (RB0/AN4/INT). When the pin is used as analog input, the ANSEL register must have the proper value to select the RB0 pin as Analog mode.

The RB1 pin is multiplexed with the A/D converter analog input 5 and the MSSP module slave select input (RB1/AN5/$\overline{SS}$). When the pin is used as analog input, the ANSEL register must have the proper value to select the RB1 pin as Analog mode.

Note:	Upon RESET, the ANSEL register configures the RB1 and RB0 pins as analog inputs. Both RB1 and RB0 pins will read as '1'.

FIGURE 3-7: BLOCK DIAGRAM OF RB0/AN4/INT, RB1/AN5/$\overline{SS}$ PIN



REGISTER 9-2: SYNC SERIAL PORT CONTROL REGISTER (SSPCON: 14h) (CONTINUED)

bit 3-0 **SSPM<3:0>:** Synchronous Serial Port Mode Select bits

0000 = SPI Master mode, clock = FOSC/4
0001 = SPI Master mode, clock = FOSC/16
0010 = SPI Master mode, clock = FOSC/64
0011 = SPI Master mode, clock = TMR2 output/2
0100 = SPI Slave mode, clock = SCK pin. $\overline{SS}$ pin control enabled.
0101 = SPI Slave mode, clock = SCK pin. $\overline{SS}$ pin control disabled. $\overline{SS}$ can be used as I/O pin.
0110 = I^2C Slave mode, 7-bit address
0111 = I^2C Slave mode, 10-bit address
1000 = I^2C Master mode, clock = FOSC / (4 • (SSPADD+1))
1001 = Reserved
1010 = Reserved
1011 = Firmware controlled Master mode (slave idle)
1100 = Reserved
1101 = Reserved
1110 = 7-bit Slave mode with START and STOP condition interrupts
1111 = 10-bit Slave mode with START and STOP condition interrupts

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

REGISTER 9-3: SYNC SERIAL PORT CONTROL REGISTER2 (SSPCON2: 91h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

bit 7 **GCEN:** General Call Enable bit (In I^2C Slave mode only)
1 = Enable interrupt when a general call address (0000h) is received in the SSPSR.
0 = General call address disabled.

bit 6 **ACKSTAT:** Acknowledge Status bit (In I^2C Master mode only)
In Master Transmit mode:
1 = Acknowledge was not received from slave
0 = Acknowledge was received from slave

bit 5 **ACKDT:** Acknowledge Data bit (In I^2C Master mode only)
In Master Receive mode:
Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
1 = Not Acknowledge (NACK)
0 = Acknowledge (ACK)

bit 4 **ACKEN:** Acknowledge Sequence Enable bit (In I^2C Master mode only).
In Master Receive mode:
1 = Initiate Acknowledge sequence on SDA and SCL pins, and transmit ACKDT data bit. Automatically cleared by hardware.
0 = Acknowledge sequence IDLE

bit 3 **RCEN:** Receive Enable bit (In I^2C Master mode only).
1 = Enables Receive mode for I^2C
0 = Receive IDLE

bit 2 **PEN:** STOP Condition Enable bit (In I^2C Master mode only).
SCK Release Control
1 = Initiate STOP condition on SDA and SCL pins. Automatically cleared by hardware.
0 = STOP condition IDLE

bit 1 **RSEN:** Repeated START Condition Enabled bit (In I^2C Master mode only)
1 = Initiate Repeated START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = Repeated START condition IDLE

bit 0 **SEN:** START Condition Enabled bit (In I^2C Master mode only)
1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = START condition IDLE

Note: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I^2C module is not in the IDLE mode, this bit may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

9.1.4 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 9-2) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI module is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a “line activity monitor”.

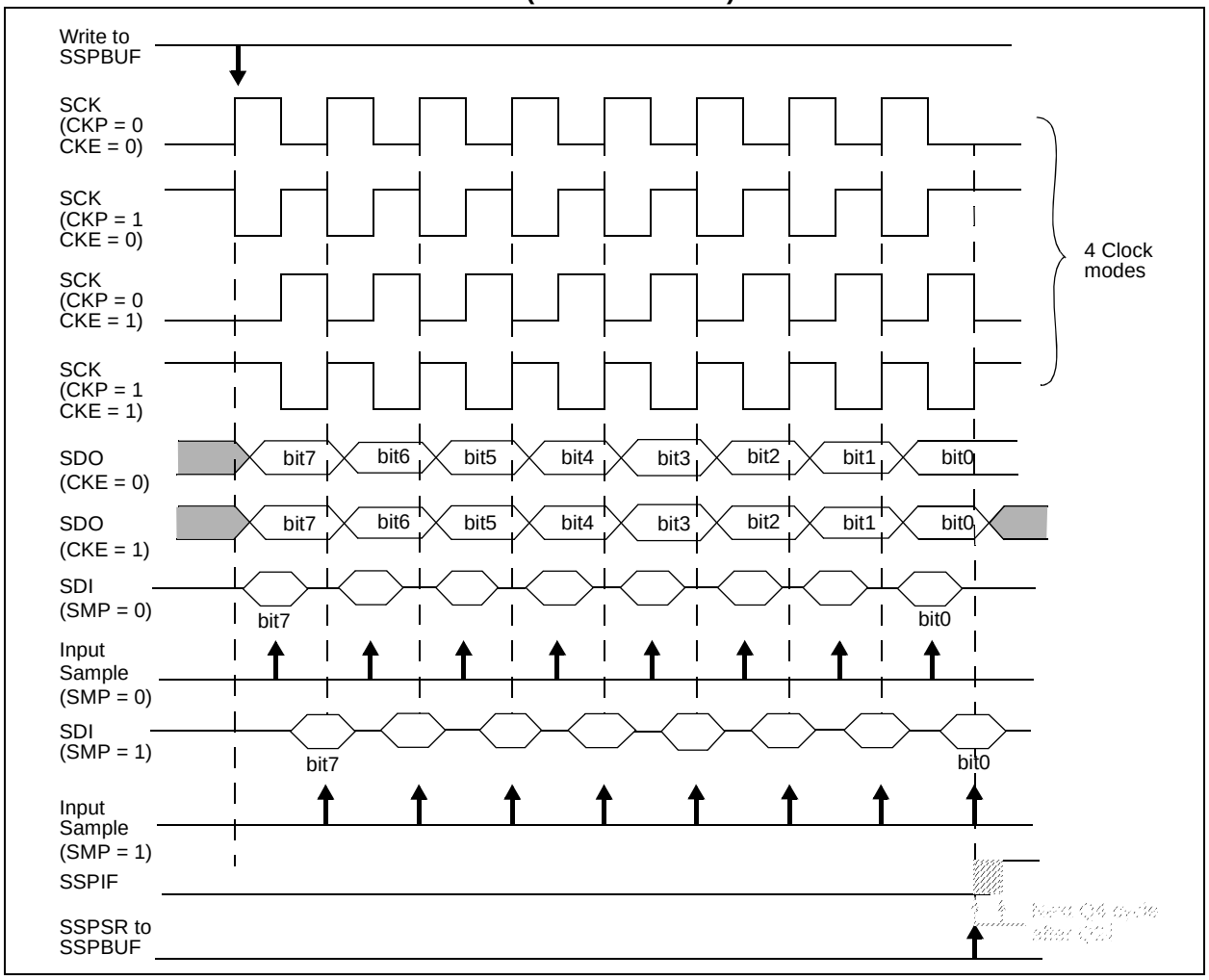
The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 9-3, Figure 9-5 and Figure 9-6, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- FOSC/4 (or TCY)
- FOSC/16 (or 4 • TCY)
- FOSC/64 (or 16 • TCY)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 8.25 MHz.

Figure 9-3 shows the waveforms for Master mode. When CKE = 1, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

FIGURE 9-3: SPI MODE WAVEFORM (MASTER MODE)



9.2.12 I²C MASTER MODE TRANSMISSION

In Master-transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains seven bits of address data and the Read/Write (R/$\overline{W}$) bit. In this case, the R/$\overline{W}$ bit will be logic '0'. Subsequent serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. START and STOP conditions are output to indicate the beginning and the end of a serial transfer.

Transmission of a data byte, a 7-bit address, or either half of a 10-bit address is accomplished by simply writing a value to the SSPBUF register. This action will set the buffer full flag (BF) and allow the baud rate generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted (see data hold time spec). SCL is held low for one baud rate generator roll over count (TBRG). Data should be valid before SCL is released high (see data setup time spec). When the SCL pin is released high, it is held that way for TBRG, the data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDA. This allows the slave device being addressed to respond with an $\overline{ACK}$ bit during the ninth bit time. The status of $\overline{ACK}$ is read into the ACKDT on the rising edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge status bit (ACKSTAT) is cleared. Otherwise, the bit is set. The SSPIF is set on the falling edge of the ninth clock, and the master clock (baud rate generator) is suspended until the next data byte is loaded into the SSPBUF leaving SCL low and SDA unchanged (Figure 9-18).

A typical transmit sequence would go as follows:

a) The user generates a START Condition by setting the START enable bit (SEN) in SSPCON2.
b) SSPIF is set at the completion of the START sequence.
c) The user resets the SSPIF bit and loads the SSPBUF with seven bits of address plus R/$\overline{W}$ bit to transmit.
d) Address and R/$\overline{W}$ is shifted out the SDA pin until all eight bits are transmitted.
e) The MSSP Module shifts in the $\overline{ACK}$ bit from the slave device, and writes its value into the SSPCON2 register (SSPCON2<6>).
f) The module generates an interrupt at the end of the ninth clock cycle by setting SSPIF.
g) The user resets the SSPIF bit and loads the SSPBUF with eight bits of data.
h) DATA is shifted out the SDA pin until all eight bits are transmitted.
i) The MSSP Module shifts in the $\overline{ACK}$ bit from the slave device and writes its value into the SSPCON2 register (SSPCON2<6>).
j) The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
k) The user resets the SSPIF bit and generates a STOP condition by setting the STOP enable bit PEN in SSPCON2.
l) SSPIF is set when the STOP condition is complete.

9.2.12.1 BF STATUS FLAG

In Transmit mode, the BF bit (SSPSTAT<0>) is set when the CPU writes to SSPBUF and is cleared when all eight bits are shifted out.

9.2.12.2 WCOL STATUS FLAG

If the user writes the SSPBUF when a transmit is already in progress (i.e. SSPSR is still shifting out a data byte), then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

WCOL must be cleared in software.

9.2.12.3 ACKSTAT STATUS FLAG

In Transmit mode, the ACKSTAT bit (SSPCON2<6>) is cleared when the slave has sent an Acknowledge ($\overline{ACK}$ = 0), and is set when the slave does not Acknowledge ($\overline{ACK}$ = 1). A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

11.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The analog-to-digital (A/D) converter module has six inputs for the PIC16C717/770/771.

The PIC16C717 analog-to-digital converter (A/D) allows conversion of an analog input signal to a corresponding 10-bit digital value, while the A/D converter in the PIC16C770/771 allows conversion to a corresponding 12-bit digital value. The A/D module has up to 6 analog inputs, which are multiplexed into one sample and hold. The output of the sample and hold is the input into the converter, which generates the result via successive approximation. The analog reference voltages are software selectable to either the device's analog positive and negative supply voltages (AV_{DD}/AV_{SS}), the voltage level on the V_{REF}+ and V_{REF}- pins, or internal voltage references if enabled (VRH, VRL).

The A/D converter can be triggered by setting the GO/DONE bit, or by the special event Compare mode of the ECCP module. When conversion is complete, the GO/DONE bit returns to '0', the ADIF bit in the PIR1 register is set, and an A/D interrupt will occur, if enabled.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D conversion clock must be derived from the A/D's internal RC oscillator.

The A/D module has four registers. These registers are:

- A/D Result Register Low ADRESL
- A/D Result Register High ADRESH
- A/D Control Register 0 (ADCON0)
- A/D Control Register 1 (ADCON1)

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off and any conversion is aborted.

11.1 Control Registers

The ADCON0 register, shown in Register 11-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 11-2, configures the functions of the port pins, the voltage reference configuration and the result format. The ANSEL register, shown in Register 3-1, selects between the Analog or Digital Port Pin modes. The port pins can be configured as analog inputs or as digital I/O.

The combination of the ADRESH and ADRESL registers contain the result of the A/D conversion. The register pair is referred to as the ADRES register. When the A/D conversion is complete, the result is loaded into ADRES, the GO/DONE bit (ADCON0<2>) is cleared, and the A/D interrupt flag ADIF is set. The block diagram of the A/D module is shown in Figure 11-3.

12.3 RESET

The PIC16C717/770/771 devices have several different RESETS. These RESETS are grouped into two classifications; power-up and non-power-up. The power-up type RESETS are the Power-on and Brown-out Resets which assume the device V_{DD} was below its normal operating range for the device's configuration. The non power-up type RESETS assume normal operating limits were maintained before/during and after the RESET.

- Power-on Reset (POR)
- Programmable Brown-out Reset (PBOR)
- $\overline{MCLR}$ Reset during normal operation
- $\overline{MCLR}$ Reset during SLEEP
- WDT Reset (during normal operation)

Some registers are not affected in any RESET condition. Their status is unknown on a Power-up Reset and unchanged in any other RESET. Most other registers are placed into an initialized state upon RESET, however they are not affected by a WDT Reset during SLEEP, because this is considered a WDT Wake-up, which is viewed as the resumption of normal operation.

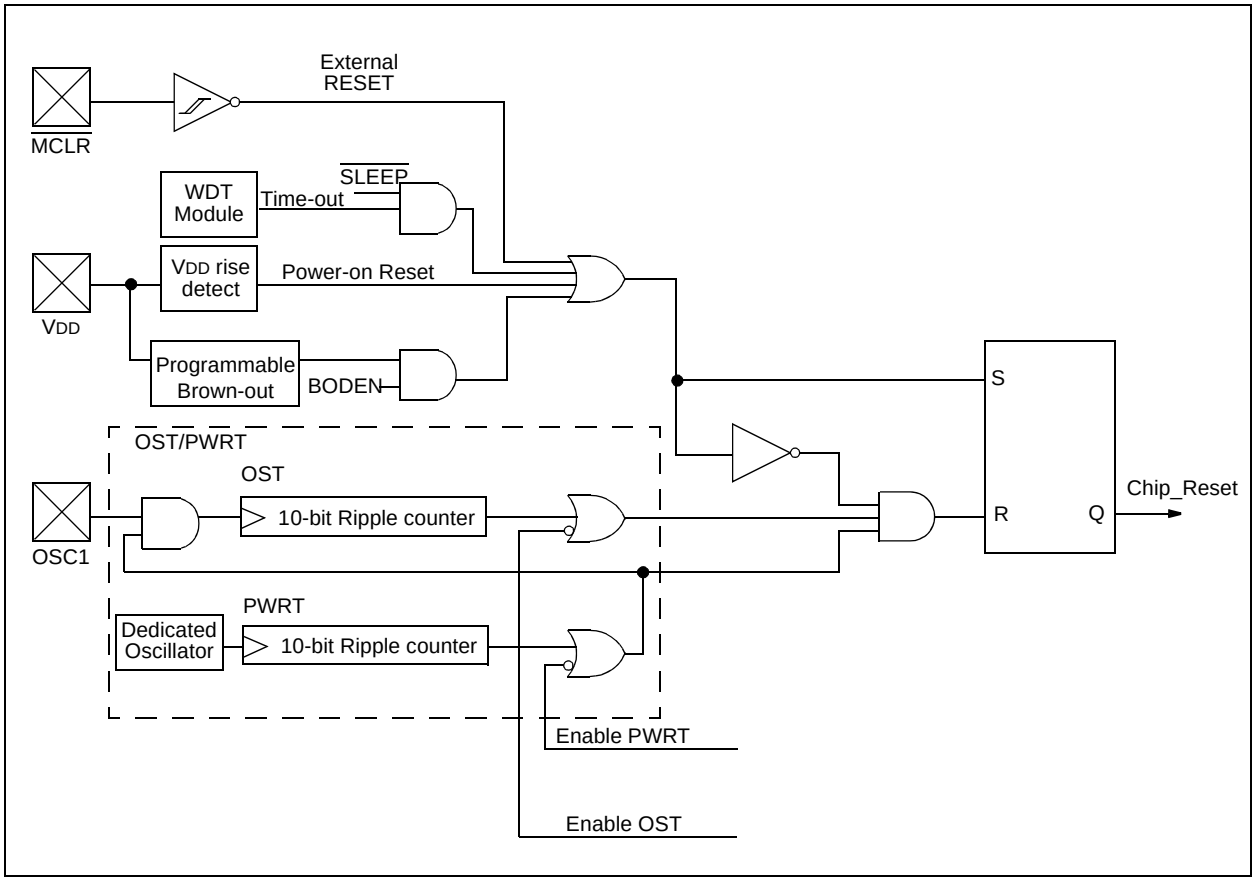
Several status bits have been provided to indicate which RESET occurred (see Table 12-4). See Table 12-6 for a full description of RESET states of all registers.

A simplified block diagram of the On-Chip Reset circuit is shown in Figure 12-4.

These devices have a $\overline{MCLR}$ noise filter in the $\overline{MCLR}$ Reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive $\overline{MCLR}$ pin low.

FIGURE 12-4: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



12.10 Interrupts

The devices have up to 11 sources of interrupt. The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note:	Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

A Global Interrupt Enable bit, GIE (INTCON<7>), enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled and an interrupt's flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in various registers. Individual interrupt bits are set, regardless of the status of the GIE bit. The GIE bit is cleared on RESET.

The "return from interrupt" instruction, `RETFIE`, exits the interrupt routine as well as sets the GIE bit, which re-enables interrupts.

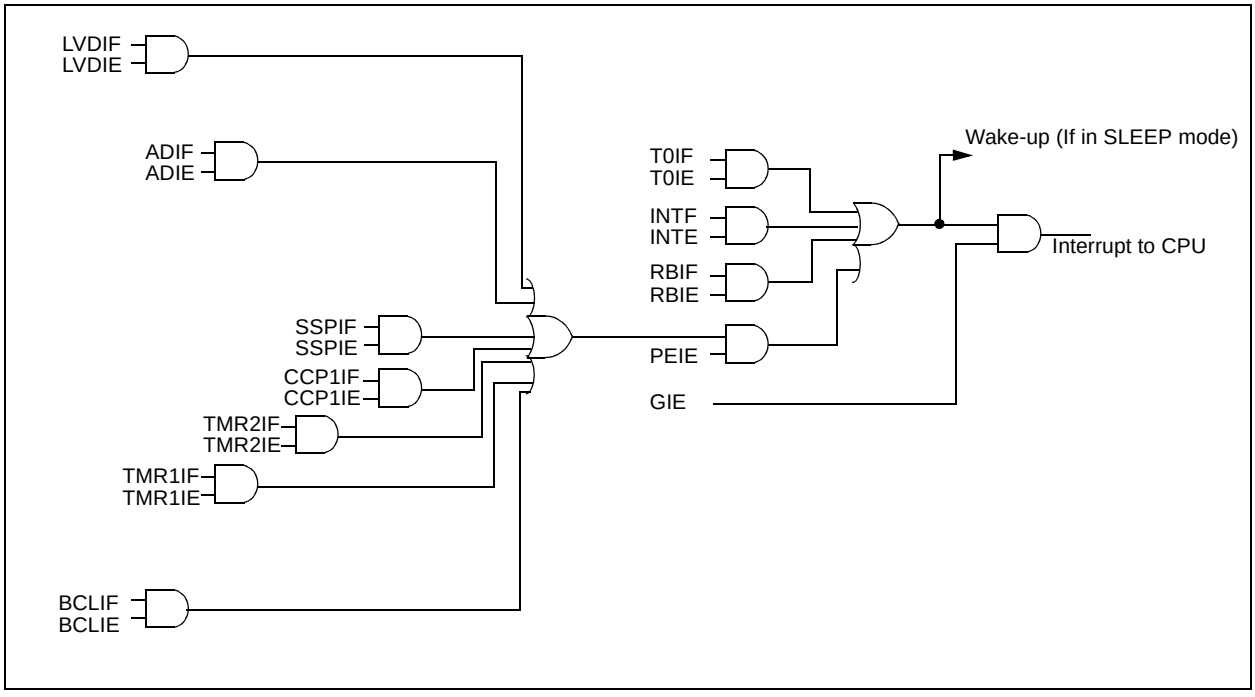
The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flags are contained in the special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2, and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, the GIE bit is cleared to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs. The latency is the same for one or two cycle instructions. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit

FIGURE 12-10: INTERRUPT LOGIC



12.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the $\overline{PD}$ bit (STATUS<3>) is cleared, the $\overline{TO}$ (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD, or VSS, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D, disable external clocks. Pull all I/O pins, that are hi-impedance inputs, high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should be considered.

12.13.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

1. External RESET input on $\overline{MCLR}$ pin.
2. Watchdog Timer Wake-up (if WDT was enabled).
3. Interrupt from INT pin, RB port change, or some Peripheral Interrupts.

External $\overline{MCLR}$ Reset will cause a device RESET. All other events are considered a continuation of program execution and cause a "wake-up". The $\overline{TO}$ and $\overline{PD}$ bits in the STATUS register can be used to determine the cause of device RESET. The $\overline{PD}$ bit, which is set on power-up, is cleared when SLEEP is invoked. The $\overline{TO}$ bit is cleared if a WDT time-out occurred (and caused wake-up).

The following peripheral interrupts can wake the device from SLEEP:

1. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
2. CCP Capture mode interrupt.
3. Special event trigger (Timer1 in Asynchronous mode using an external clock).
4. SSP (START/STOP) bit detect interrupt.
5. SSP transmit or receive in Slave mode (SPI/I^2C).
6. A/D conversion (when A/D clock source is RC).
7. Low Voltage detect.

Other peripherals cannot generate interrupts since during SLEEP, no on-chip clocks are present.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

12.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the $\overline{TO}$ bit will not be set and $\overline{PD}$ bits will not be cleared.
- If the interrupt occurs **during or after** the execution of a SLEEP instruction, the device will immediately wake-up from SLEEP. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the $\overline{TO}$ bit will be set and the $\overline{PD}$ bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the $\overline{PD}$ bit. If the $\overline{PD}$ bit is set, the SLEEP instruction was executed as a NOP.

If a peripheral can wake the device from SLEEP, then to ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

13.0 INSTRUCTION SET SUMMARY

Each PIC16CXXX instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CXX instruction set summary in Table 13-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 13-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 13-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
PC	Program Counter
$\overline{TO}$	Time-out bit
$\overline{PD}$	Power-down bit

The instruction set is highly orthogonal and is grouped into three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs.

Table 13-2 lists the instructions recognized by the MPASM™ assembler.

Figure 13-1 shows the general formats that the instructions can have.

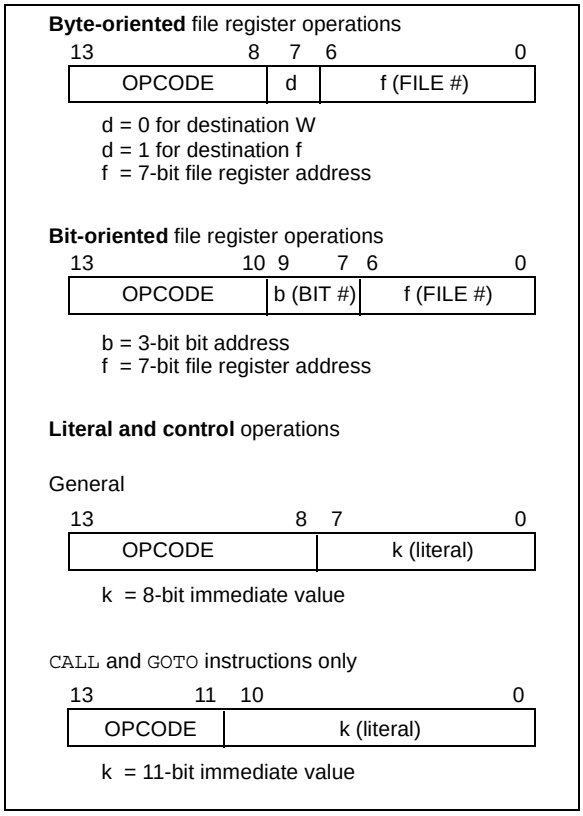
Note: To maintain upward compatibility with future PIC16CXXX products, do not use the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 13-1: GENERAL FORMAT FOR INSTRUCTIONS



A description of each instruction is available in the PIC Mid-Range MCU Family Reference Manual, (DS33023).

15.1 DC Characteristics: PIC16C717/770/771 (Commercial, Industrial, Extended) PIC16LC717/770/771 (Commercial, Industrial, Extended) (Continued)

PIC16LC717/770/771			**Standard Operating Conditions (unless otherwise stated)** Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
PIC16C717/770/771			**Standard Operating Conditions (unless otherwise stated)** Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param. No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
	IDD	**Supply Current(2)**					
D010D		**PIC16LC7XX**		1.0	2.0	mA	FOSC = 10 MHz, VDD = 3V, -40°C to 85°C
D010E					3.0		FOSC = 10 MHz, VDD = 3V, -40°C to 125°C
D010G				0.36	1.0	mA	FOSC = 4 MHz, VDD = 2.5V, -40°C to 125°C
D010K				11	45	µA	FOSC = 32 kHz, VDD = 2.5V, -40°C to 125°C
	IDD	**Supply Current(2)**					
D010		**PIC16C7XX**		4.0	7.5	mA	FOSC = 20 MHz, VDD = 5.5V, -40°C to 85°C
D010A					12.0		FOSC = 20 MHz, VDD = 5.5V, -40°C to 125°C
D010B				2.5	5.0	mA	FOSC = 20 MHz, VDD = 4V, -40°C to 85°C
D010C					6.0		FOSC = 20 MHz, VDD = 4V, -40°C to 125°C
D010F				0.55	1.5	mA	FOSC = 4 MHz, VDD = 4V, -40°C to 125°C
D010H				30	80	µA	FOSC = 32 kHz, VDD = 4V, -40°C to 85°C
D010J					95		FOSC = 32 kHz, VDD = 4V, -40°C to 125°C

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
The test conditions for all IDD measurements in active Operation mode are:
OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD
$\overline{MCLR}$ = VDD; WDT enabled/disabled as specified.

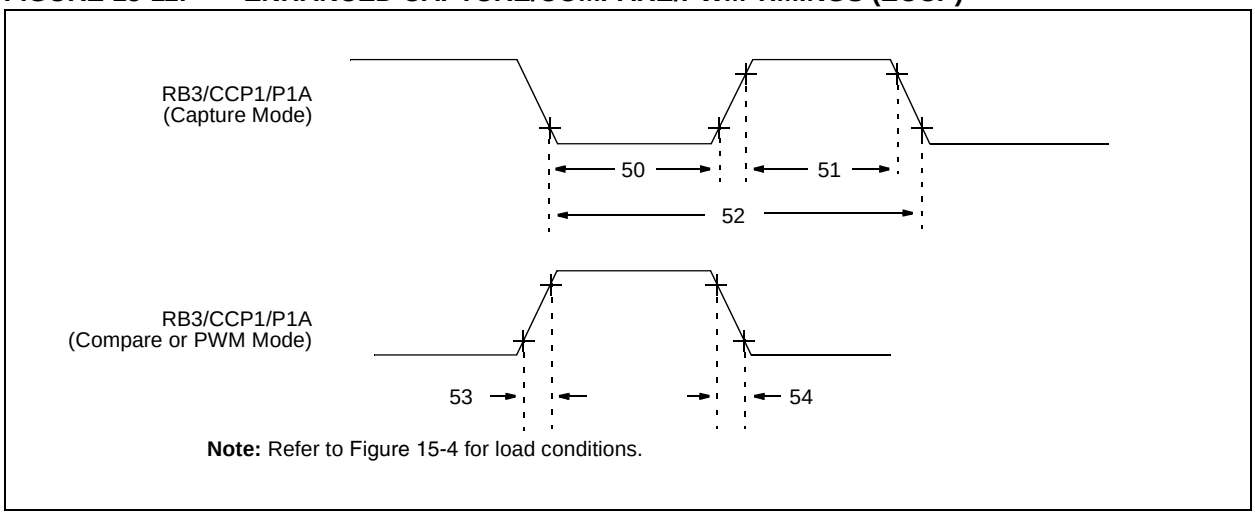
TABLE 15-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param. No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width		No Prescaler	0.5TCY + 20	—	—	ns	Must also meet parameter 42
				With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width		No Prescaler	0.5TCY + 20	—	—	ns	Must also meet parameter 42
				With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		No Prescaler	TCY + 40	—	—	ns	
				With Prescaler	Greater of: 20 or TCY + 40 / N	—	—	ns	N = prescale value (2, 4, ..., 256)
45*	Tt1H	T1CKI High Time	Synchronous, Prescaler = 1		0.5TCY + 20	—	—	ns	Must also meet parameter 47
			Synchronous, Prescaler = 2,4,8	PIC16**C**717/770/771	15	—	—	ns	
				PIC16**LC**717/770/771	25	—	—	ns	
			Asynchronous	PIC16**C**717/770/771	30	—	—	ns	
				PIC16**LC**717/770/771	50	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, Prescaler = 1		0.5TCY + 20	—	—	ns	Must also meet parameter 47
			Synchronous, Prescaler = 2,4,8	PIC16**C**717/770/771	15	—	—	ns	
				PIC16**LC**717/770/771	25	—	—	ns	
			Asynchronous	PIC16**C**717/770/771	30	—	—	ns	
				PIC16**LC**717/770/771	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16**C**717/770/771	Greater of: 30 OR TCY + 40 / N	—	—	ns	N = prescale value (1, 2, 4, 8)
				PIC16**LC**717/770/771	Greater of: 50 OR TCY + 40 / N	—	—	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16**C**717/770/771	60	—	—	ns	
				PIC16**LC**717/770/771	100	—	—	ns	
	Ft1	Timer1 oscillator input frequency range (oscillator enabled by setting bit T1OSCEN)			DC	—	50	kHz	
48	Tcke2tmr1	Delay from external clock edge to timer increment			2Tosc	—	7Tosc	—	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 15-11: ENHANCED CAPTURE/COMPARE/PWM TIMINGS (ECCP)



Note: Refer to Figure 15-4 for load conditions.

FIGURE 15-20: SPI SLAVE MODE TIMING (CKE = 0)

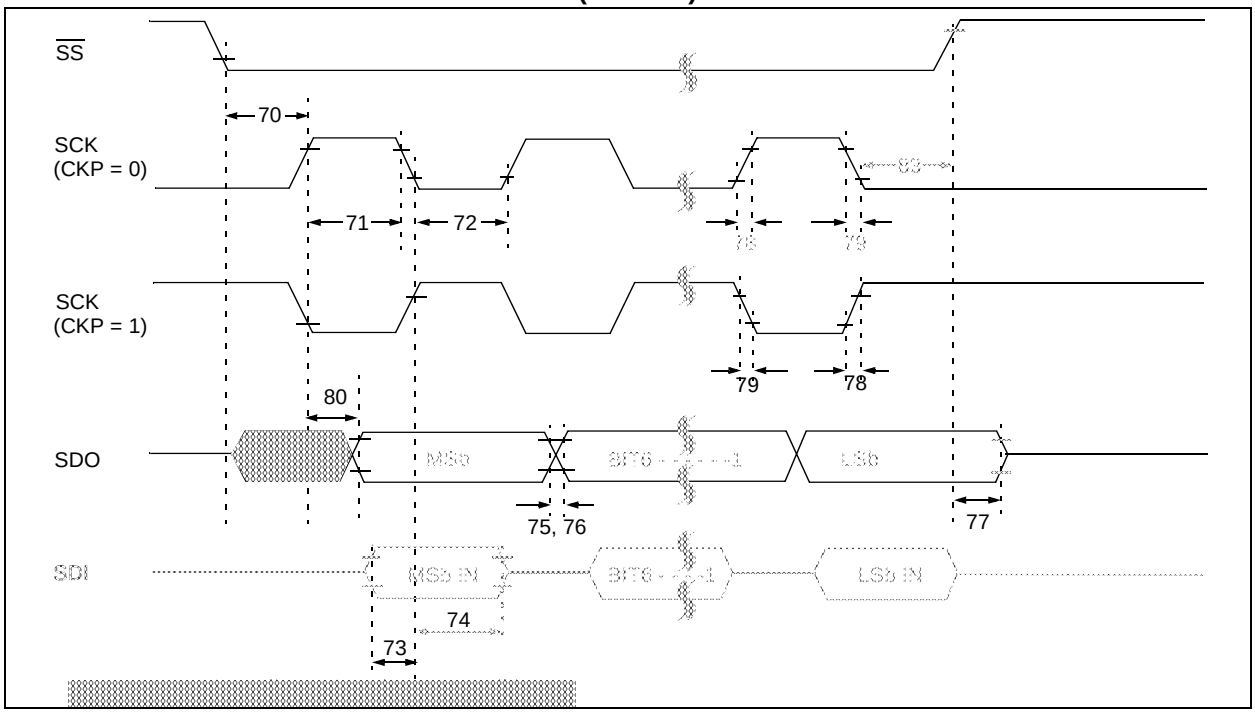


TABLE 15-19: SPI MODE REQUIREMENTS (SLAVE MODE TIMING (CKE = 0)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}$↓ to SCK↓ or SCK↑ input		TCY	—	—	ns	
71*	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A*			Single Byte	40	—	—	ns	**Note 1**
72*	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A*			Single Byte	40	—	—	ns	**Note 1**
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A*	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**Note 1**
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75*	TdoR	SDO data output rise time	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
76*	TdoF	SDO data output fall time		—	10	25	ns	
77*	TssH2doZ	$\overline{SS}$↑ to SDO output hi-impedance		10	—	50	ns	
78*	TscR	SCK output rise time (Master mode)	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX		20	45	ns	
79*	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC16**C**XXX	—	—	50	ns	
			PIC16**LC**XXX		—	100	ns	
83*	TscH2ssH, TscL2ssH	$\overline{SS}$ ↑ after SCK edge		1.5TCY + 40	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 16-2: TYPICAL IDD VS. FOSC OVER VDD (HS MODE)

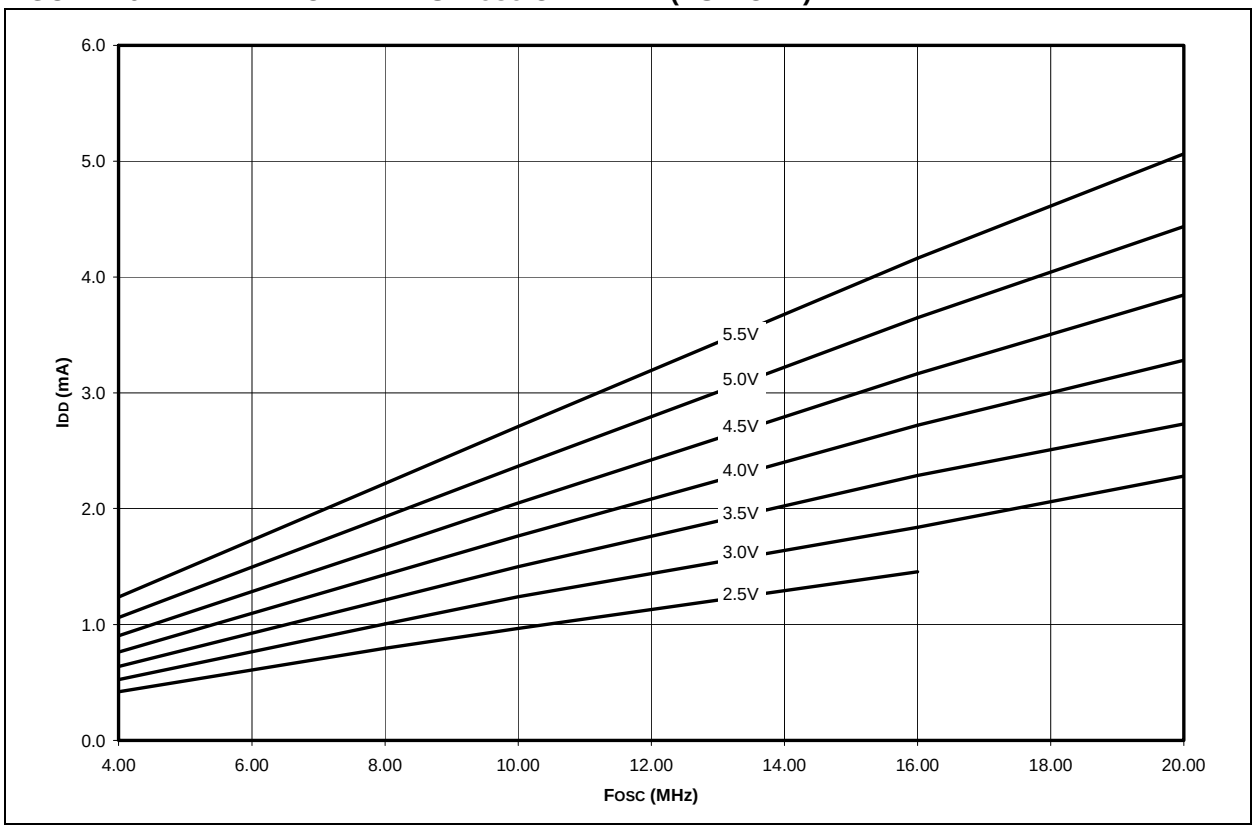


FIGURE 16-3: MAXIMUM IDD VS. FOSC OVER VDD (XT MODE)

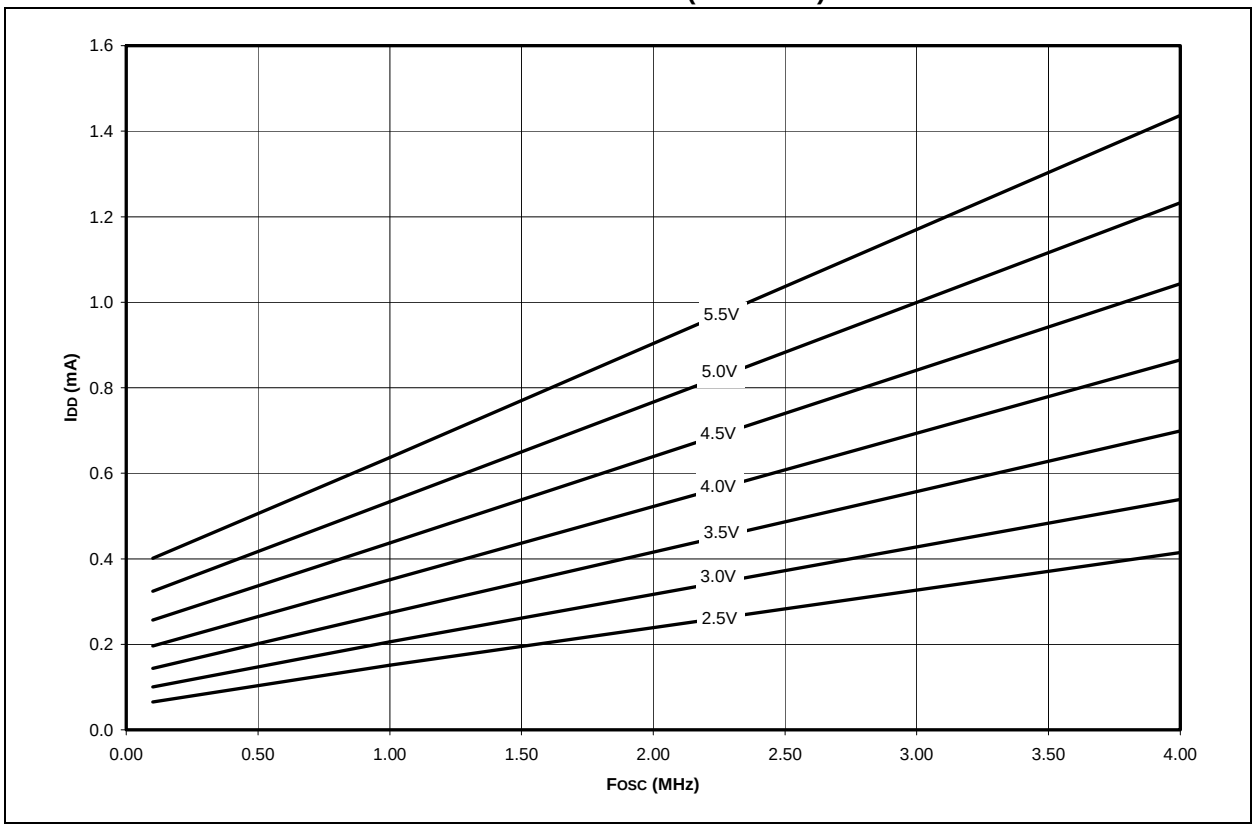


FIGURE 16-14: INTERNAL RC FOSC VS. VDD OVER TEMPERATURE (37 kHZ)

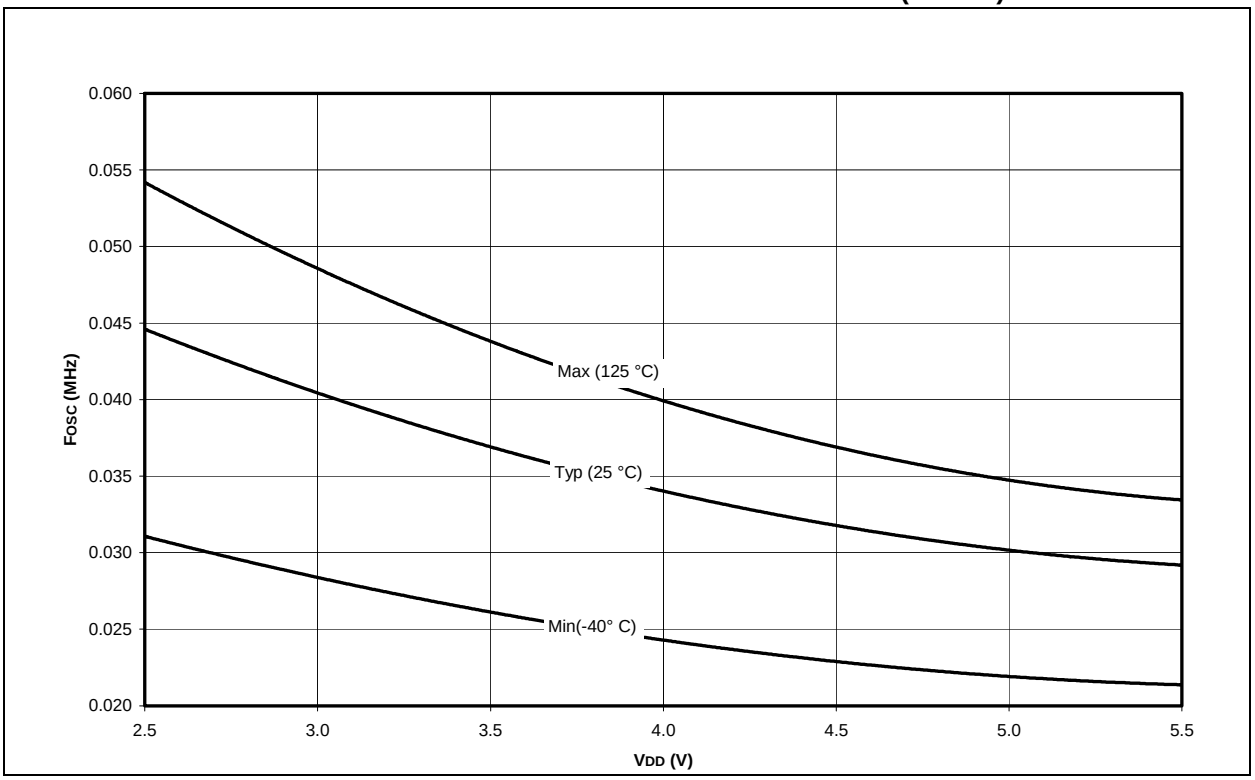


FIGURE 16-15: MAXIMUM AND TYPICAL IDD VS. VDD (INTRC 4 MHz MODE)

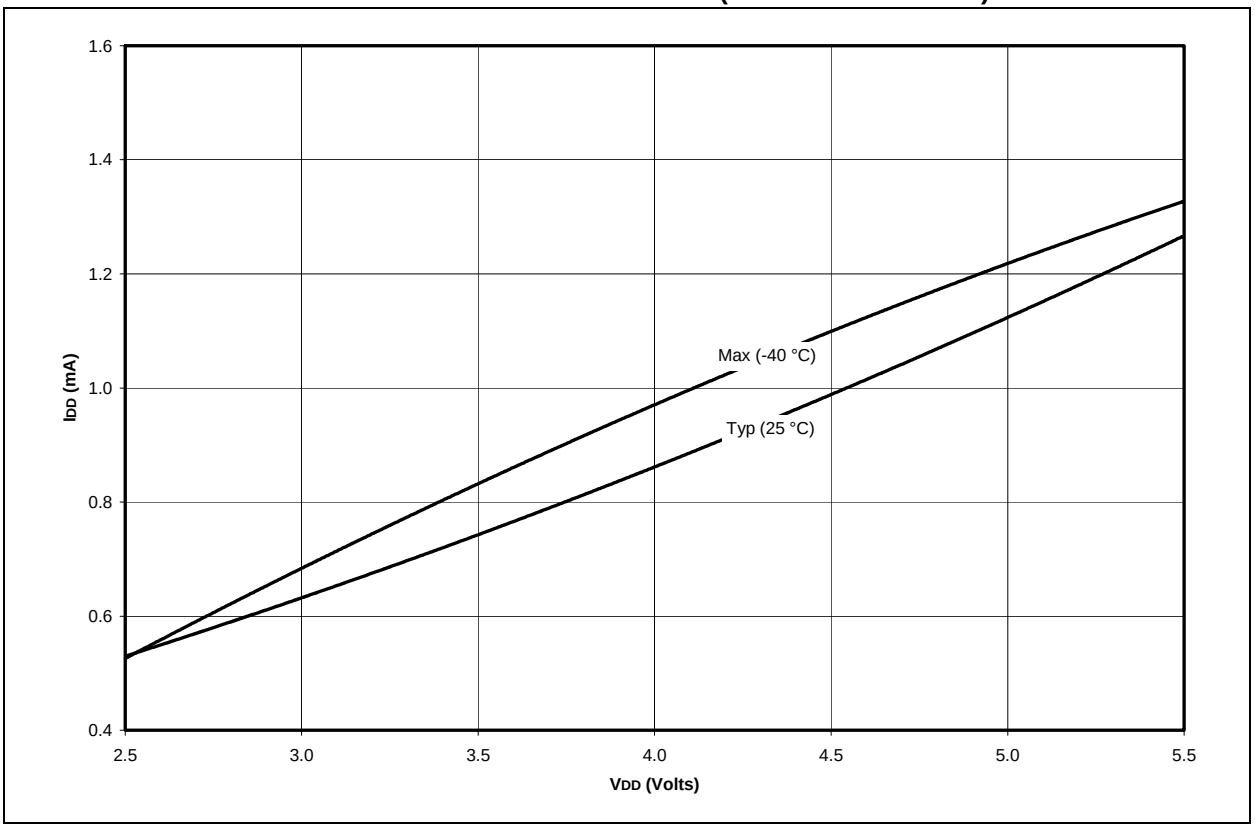


FIGURE 16-22: TYPICAL AND MAXIMUM ΔIVRH VS. VDD (-40°C TO +125°C)

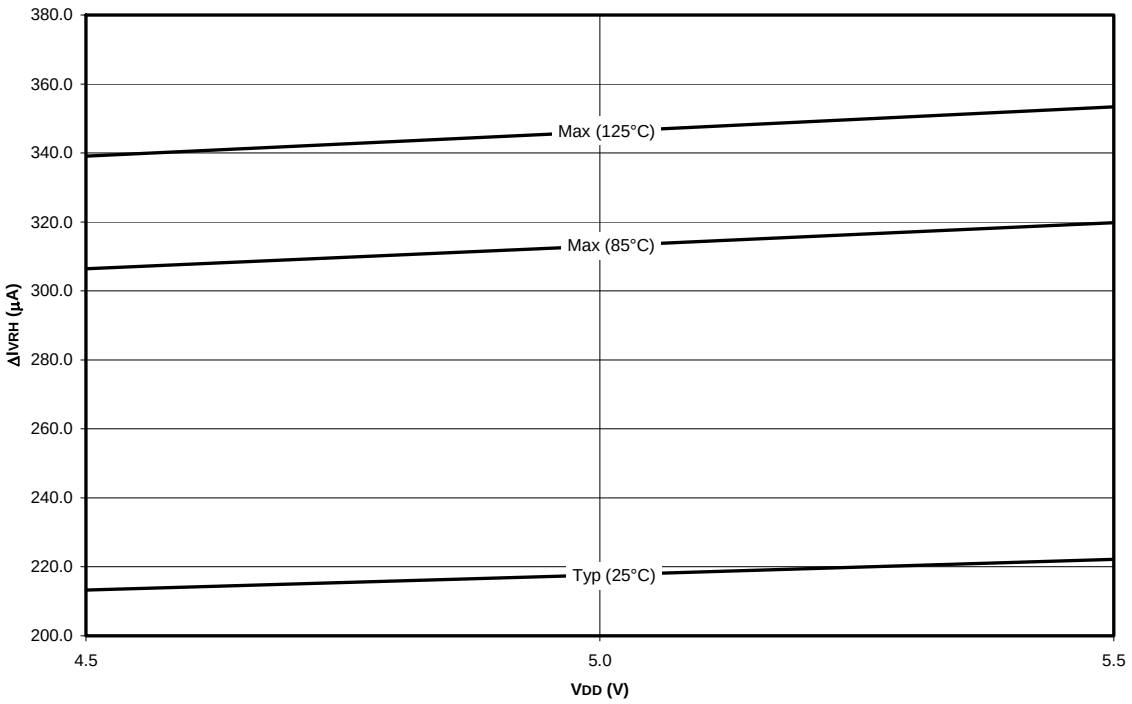
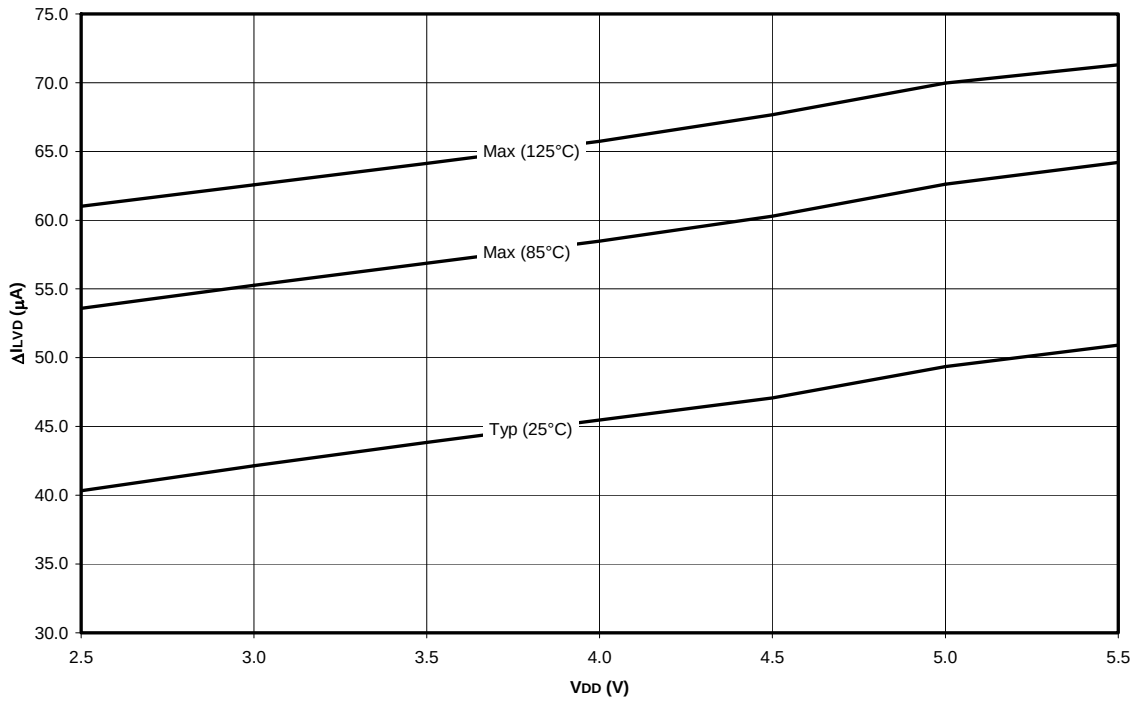


FIGURE 16-23: TYPICAL AND MAXIMUM ΔILVD VS. VDD (-40°C TO +125°C) (LVD TRIP = 3.0V)



NOTES: